



# **SPECIFICATION**

(Reference sheet)

· Supplier : Samsung electro-mechanics · Samsung P/N : CL03A104MA3NNNC

Product : Multi-layer Ceramic Capacitor

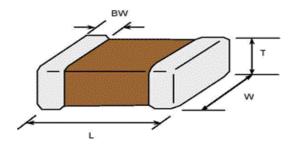
Description : CAP, 100nF, 25V, ±20%, X5R, 0201

### A. Samsung Part Number

<u>CL</u> <u>03</u> <u>A</u> <u>104</u> <u>M</u> <u>A</u> <u>3</u> <u>N</u> <u>N</u> <u>N</u> <u>C</u> 1 2 3 4 5 6 7 8 9 10 11

1	Series	Samsung Multi-layer Ceramic Capacitor					
2	Size	0201 (inch code)	L: $0.60 \pm 0.03$ mm		W:	$0.30 \pm 0.03$ mm	
3	Dielectric	X5R	8	Inner electrode		Ni	
4	Capacitance	100 nF		Termination		Cu	
(5)	Capacitance	±20 %		Plating		Sn 100% (Pb Free)	
	tolerance		9	Product		Normal	
6	Rated Voltage	25 V	10	Special		Reserved for future use	
7	Thickness	$0.30 \pm 0.03$ mm	11	Packaging		Cardboard Type, 7" reel	

#### **B. Structure & Dimension**



Samsung P/N	Dimension(mm)					
Samsung F/N	L	W	Т	BW		
CL03A104MA3NNNC	0.60 ± 0.03	0.30 ± 0.03	0.30 ± 0.03	0.15 ± 0.05		

#### C. Samsung Reliablility Test and Judgement Condition

Capacitance       Within specified tolerance       1 kHz ±10% / 1.0±0.2Vrms         *A capacitor prior to measuring the capacitance treated at 150 ℃+0/-10 ℃ for 1 hour and maintain ambient air for 24±2 hours.         Insulation       10,000Mohm or 100Mohm×μF       Rated Voltage       60~120 sec.         Resistance       Whichever is smaller         Appearance       No abnormal exterior appearance       Microscope (×10)         Withstanding       No dielectric breakdown or mechanical breakdown       250% of the rated voltage         Voltage       mechanical breakdown         Temperature       X5R			
Tan δ (DF)       0.1 max.       treated at 150 ℃ +0/-10 ℃ for 1 hour and maintain ambient air for 24±2 hours.         Insulation       10,000Mohm or 100Mohm×μF       Rated Voltage       60~120 sec.         Resistance       Whichever is smaller       Microscope (×10)         Appearance       No abnormal exterior appearance       Microscope (×10)         Withstanding       No dielectric breakdown or       250% of the rated voltage         Voltage       mechanical breakdown			
Resistance Whichever is smaller  Appearance No abnormal exterior appearance Microscope (×10)  Withstanding No dielectric breakdown or 250% of the rated voltage  Voltage mechanical breakdown			
Appearance       No abnormal exterior appearance       Microscope (×10)         Withstanding       No dielectric breakdown or Voltage       250% of the rated voltage			
Withstanding No dielectric breakdown or 250% of the rated voltage Voltage mechanical breakdown			
Voltage mechanical breakdown			
-			
Characteristics (From-55 °C to 85 °C, Capacitance change should be within ±15%)	nould be within ±15%)		
Adhesive Strength No peeling shall be occur on the 200g f, for 10±1 sec.			
of Termination terminal electrode			
Bending Strength Capacitance change: within ±12.5% Bending to the limit (1mm)			
with 1.0mm/sec.			
Solderability More than 75% of terminal surface SnAg3.0Cu0.5 solder			
is to be soldered newly 245±5°C, 3±0.3sec.			
(preheating : 80~120°C for 10~30sec.)			
Resistance to Capacitance change: within ±7.5% Solder pot: 270±5°C, 10±1sec.			
Soldering Heat Tan δ, IR : initial spec.			
Vibration TestCapacitance change : within $\pm$ 5%Amplitude : 1.5mmTan δ, IR : initial spec.From 10Hz to 55Hz (return : 1min.)2hours $\times$ 3 direction (x, y, z)			
Moisture Capacitance change: within ±12.5% With rated voltage			
Resistance         Tan δ :         0.2 max         40±2°C, 90~95%RH, 500+12/-0hrs			
IR: 500Mohm or 7.5Mohm × $\mu$ F			
Whichever is smaller			
High Temperature Capacitance change: within ±12.5% With 150% of the rated voltage			
Resistance       Tan δ :       0.2 max       Max. operating temperature			
IR : 1,000Mohm or 15Mohm × μ 1000+48/-0hrs			
Whichever is smaller			
Temperature Capacitance change: within ±7.5% 1 cycle condition			
Cycling       Tan δ, IR : initial spec.       Min. operating temperature $\rightarrow$ 25°C			
→ Max. operating temperature → 25°C			
5 cycle test			

X The reliability test condition can be replaced by the corresponding accelerated test condition.

#### D. Recommended Soldering method:

Reflow ( Reflow Peak Temperature : 260±5°C, 30sec.)



A Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications,

please contact our sales personnel or application engineers.

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The products listed in this Specification sheet are **NOT** designed and manufactured for any use and applications set forth below.

Please note that any misuse of the products deviating from products specifications or information provided in this Spec sheet may cause serious property damages or personal injury.

We will **NOT** be liable for any damages resulting from any misuse of the products, specifically including using the products for high reliability applications as listed below.

If you have any questions regarding this 'Limitation of Use and Application', you should first contact our sales personnel or application engineers.

- ① Aerospace/Aviation equipment
- 2 Automotive or Transportation equipment (vehicles, trains, ships, etc)
- 3 Medical equipment
- 4 Military equipment
- ⑤ Disaster prevention/crime prevention equipment
- 6 Power plant control equipment
- Atomic energy-related equipment
- Undersea equipment
- Traffic signal equipment
- Data-processing equipment
- ## Electric heating apparatus, burning equipment
- Safety equipment
- ® Any other applications with the same as or similar complexity or reliability to the applications